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03226.111001;P0259

**Applicant(s)**

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Filing Date

Group Art Unit

[illegible]

10/085183  
02/27/02

	REF	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation	
							YES	NO
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C.C.	A1	<p>"Thermal Performance Challenges from Silicon to Systems" (pages 1-16)  published in INTEL TECHNOLOGY JOURNAL Q3, 2000  Authors: Ram Viswanath, Technology and Manufacturing Group, Intel Corp.; Vijay Wakharkar, Technology and Manufacturing Group, Intel Corp.; Abhay Watwe, Technology and Manufacturing Group, Intel Corp.; and, Vassou Lebonheur, Technology and Manufacturing Group, Intel Corp.</p>

**EXAMINER**

**DATE CONSIDERED**

11/21/02

**Form PTO-A820**  
**(also form PTO-1449)**

P09A/REV04

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